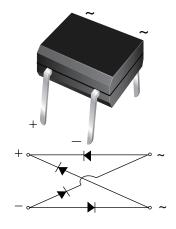


Vishay General Semiconductor

Miniature Glass Passivated Single-Phase Bridge Rectifiers



Case Style MBM LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | |
|-------------------------|---------------------|--|--|--|
| I _{F(AV)} | 0.5 A | | | |
| V _{RRM} | 200 V, 400 V, 600 V | | | |
| I _{FSM} | 30 A | | | |
| I _R | 5 μΑ | | | |
| V_F at $I_F = 0.5 A$ | 1.0 V | | | |
| T _J max. | 150 °C | | | |
| Package | MBM | | | |
| Circuit configuration | Quad | | | |

FEATURES

- UL recognized, file number E54214
- Ideal for printed circuit boards
- Applicable for automative insertion
- Middle surge current capability
- Recommended for non-automotive applications
- Solder dip 275 °C max. 10 s, per JESD 22-B106
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for power supply, lighting ballaster, battery charger, home appliances, office equipment, and telecommunication applications.

MECHANICAL DATA

Case: MBM

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: as marked on body

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | |
|--|-----------------------------------|-------------|-----|------|------------------|
| PARAMETER | SYMBOL | B2M B4M B6M | | UNIT | |
| Device marking code | | B2 | B4 | B6 | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 200 400 600 | | 600 | V |
| Maximum RMS voltage | V _{RMS} | 140 280 420 | | 420 | V |
| Maximum DC blocking voltage | V _{DC} | 200 | 400 | 600 | V |
| Maximum average forward output rectified current (fig. 1) on glass-epoxy PCB | I _{F(AV)} | 0.5 (1) | | | А |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load (JEDEC method) | I _{FSM} | 30 | | | А |
| Rating for fusing (t < 8.3 ms) | l ² t | 5.0 | | | A ² s |
| Operating junction and storage temperature range | T _J , T _{STG} | -55 to +150 | | | °C |

Note

⁽¹⁾ On glass epoxy PCB mounted on 0.05" x 0.05" (1.3 mm x 1.3 mm) pads

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| ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted) | | | | | | |
|---|-------------------------|----------------|-----|-----|-----|------|
| PARAMETER | TEST CONDITIONS | SYMBOL | B2M | B4M | B6M | UNIT |
| Maximum instantaneous forward voltage drop per diode | I _F = 0.5 A | V _F | 1.0 | | V | |
| Maximum DC reverse current at rated DC blocking voltage per diode | T _A = 25 °C | 1 | | 5.0 | | |
| | T _A = 125 °C | IR | 100 | | μΑ | |
| Typical junction capacitance per diode | 4.0 V, 1 MHz | CJ | 13 | | | pF |

| THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted) | | | | | | |
|--|------------------|-----|------|--|------|--|
| PARAMETER SYMBOL B2M B4M B6M | | B6M | UNIT | | | |
| Typical thermal resistance ⁽¹⁾ | R _{θJA} | 90 | | | °C/W | |
| | R _{θJL} | 40 | | | | |

Note

 $^{(1)}\,$ On glass epoxy PCB mounted on 0.05" x 0.05" (1.3 mm x 1.3 mm) pads

| ORDERING INFORMATION (Example) | | | | | | |
|--------------------------------|-----------------|------------------------|---------------|---------------|--|--|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE | | |
| B2M-E3/45 | 0.22 | 45 | 100 | Tube | | |

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

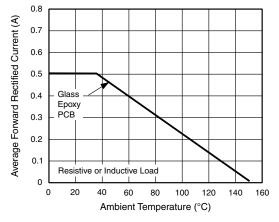


Fig. 1 - Derating Curve for Output Rectified Current

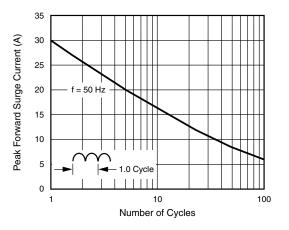


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current . Per Diode

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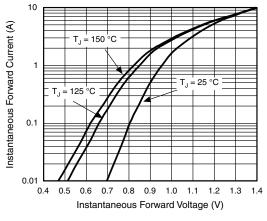


Fig. 3 - Typical Forward Voltage Characteristics Per Diode

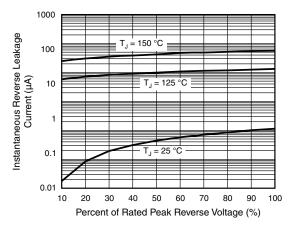
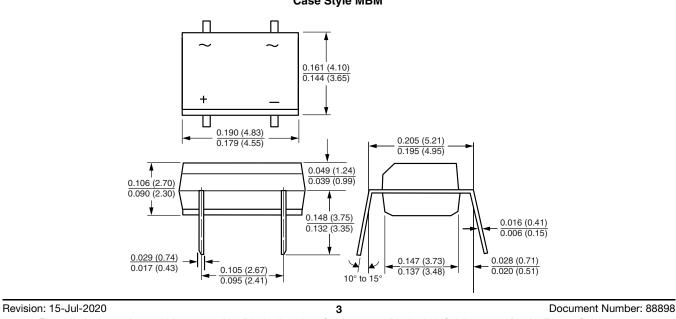


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode



PACKAGE OUTLINE DIMENSIONS in inches (millimeters) Case Style MBM

Reverse Voltage (V) Fig. 5 - Typical Junction Capacitance Per Diode

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